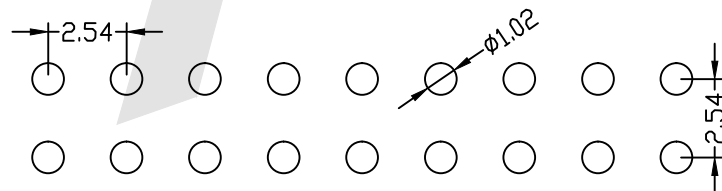
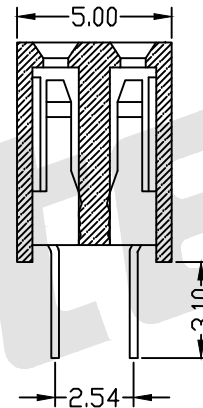
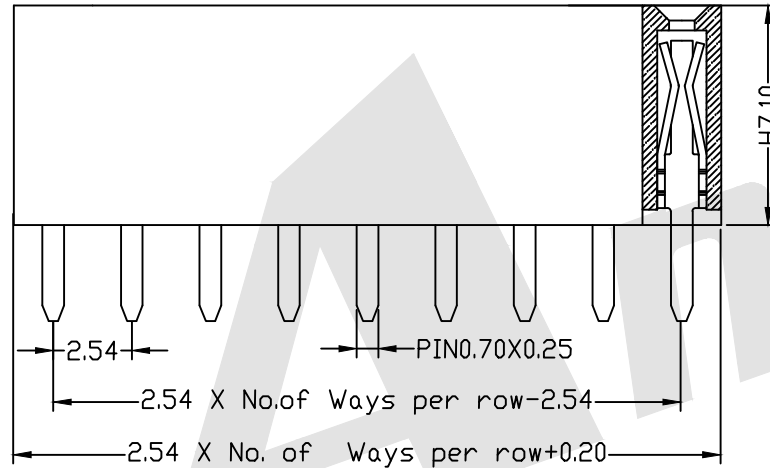
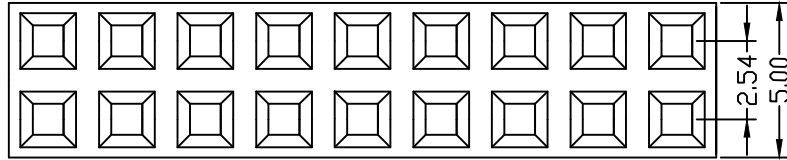


HSF



PCB LAYOUT

SPECIFICATION

Current Rating: 3.0 Amp
 Insulation Resistance: 1000M ohms min
 Contact Resistance: 20M ohms max
 Dielectric Withstanding: AC500V
 Operating Temperature: -65°C to +125°C
 Contact Material: Brass
 Insulator Material: PBT,UL 94V-0 Black

Ordering Code:

FHES10 - X - X - D - X - X - X
 ① ② ③ ④ ⑤ ⑥ ⑦

- ① Series No:
- ② No. of Contacts: 02 To 80
- ③ Contact Plating: G0:Gold flash S0:Selective
 G1:3U" Gold S1:Selective 3u" ⑦ Packing
 G2:5u" Gold S2:Selective 5u" A:Tray
 G3:10u" Gold S3:Selective 10u" B:Bag
 G4:15u" Gold S4:Selective 15u" T:Tube
 G5:30u" Gold S5:Selective 30u" U:Tube+CAP
 SN: Tin R:Tape&Reel
 W:Tape&Reel+CAP
- ④ Connector Type: D: Dual
- ⑤ Plastic High: H:7.1
 Please mark the desired length in the H
- ⑥ Insulator Material: A:PBT, B:PA6T, C:LCP, D:PA46, E:PA9T

Unless Otherwise specified tolerance
 X. ±0.35 X.XX: ±0.20
 X.X: ±0.25 X.XXX: ±0.15

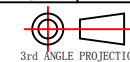
SCALE: As Shown	UNIT: mm
DRAW YG ZHONG	DATE 01/05/2016
CHECK BobYang	DATE 01/05/2016

Antenk ANTENK ELECTRONICS CO., LTD
 Http://www.antenk.com
 E-mail:sales@antenk.com

TITLE:
2.54mm Female Header Dual Row Straight Type(W=5.0 H=7.1)

DRAWING NO: FHES10-XXDXXX

PRODUCT NO: FHES10-XXDXXX



REV	DESCRIPTION	DATE
1		
2		
3		
4		
5		